

## N-Channel Power MOSFET

600V, 0.5A, 10Ω

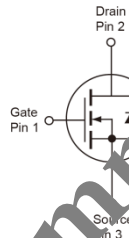
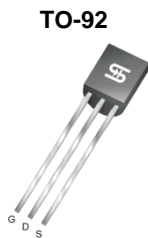
### FEATURES

- 100% Avalanche Tested
- Pb-free plating
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

### APPLICATIONS

- Power Supply
- AC/DC LED Lighting

KEY PERFORMANCE PARAMETERS		
PARAMETER	VALUE	UNIT
$V_{DS}$	600	V
$R_{DS(on)}$ (max)	10	Ω
$Q_g$	6.1	nC



### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ , unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	$V_{DS}$	600	V
Gate-Source Voltage	$V_{GS}$	±30	V
Continuous Drain Current (Note 1)	$I_D$	$T_C = 25^\circ\text{C}$	0.5
		$T_C = 100^\circ\text{C}$	0.25
Pulsed Drain Current (Note 2)	$I_{DM}$	2	A
Single Pulse Avalanche Energy (Note 3)	$E_{AS}$	5	mJ
Peak Diode Recovery $dv/dt$ (Note 4)	$dv/dt$	4.5	V/ns
Total Power Dissipation @ $T_C = 25^\circ\text{C}$	$P_{DTOT}$	2.5	W
Operating Junction Temperature	$T_J$	150	°C
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	- 55 to +150	°C

### THERMAL PERFORMANCE

PARAMETER	SYMBOL	LIMIT	UNIT
Junction to Lead Thermal Resistance	$R_{\theta JL}$	50	°C/W
Junction to Ambient Thermal Resistance	$R_{\theta JA}$	110	°C/W

**Thermal Performance Note:**  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistances. The case-thermal reference is defined at the solder mounting surface of the drain pins.  $R_{\theta JA}$  is guaranteed by design while  $R_{\theta CA}$  is determined by the user's board design.  $R_{\theta JA}$  shown below for single device operation on FR-4 PCB with minimum recommended footprint in still air.

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_A = 25^\circ\text{C}$ unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
<b>Static</b> (Note 5)						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	$BV_{DSS}$	600	--	--	V
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	$V_{GS(TH)}$	2.5	3.5	4.5	V
Gate Body Leakage	$V_{GS} = \pm 30V, V_{DS} = 0V$	$I_{GSS}$	--	--	$\pm 100$	nA
Zero Gate Voltage Drain Current	$V_{DS} = 600V, V_{GS} = 0V$	$I_{DSS}$	--	--	10	$\mu A$
Drain-Source On-State Resistance	$V_{GS} = 10V, I_D = 0.25A$	$R_{DS(ON)}$	--	8	10	$\Omega$
Forward Transfer Conductance	$V_{DS} = 10V, I_D = 0.5A$	$g_{fs}$	--	0.8	--	S
<b>Dynamic</b> (Note 6)						
Total Gate Charge	$V_{DS} = 480V, I_D = 0.5A,$ $V_{GS} = 10V$	$Q_g$	--	6.1	--	nC
Gate-Source Charge		$Q_{gs}$	--	1.4	--	
Gate-Drain Charge		$Q_{gd}$	--	3.3	--	
Input Capacitance	$V_{DS} = 25V, V_{GS} = 0V,$ $F = 1.0MHz$	$C_{iss}$	--	138	--	pF
Output Capacitance		$C_{oss}$	--	17.1	--	
Reverse Transfer Capacitance		$C_{rss}$	--	4.2	--	
<b>Switching</b> (Note 7)						
Turn-On Delay Time	$V_{GS} = 10V, I_D = 0.5A,$ $V_{DD} = 300V, R_G = 5\Omega$	$t_{d(on)}$	--	7.7	--	ns
Turn-On Rise Time		$t_r$	--	6.8	--	
Turn-Off Delay Time		$t_{d(off)}$	--	15.3	--	
Turn-Off Fall Time		$t_f$	--	14.9	--	
<b>Source-Drain Diode</b> (Note 5)						
Source Current	Integral reverse diode in the MOSFET	$I_S$	--	--	0.5	A
Source Current (Pulse)		$I_{SM}$	--	--	2	A
Diode Forward Voltage	$I_S = 0.5A, V_{GS} = 0V$	$V_{SD}$	--	0.9	1.4	V

**Notes:**

1. Current limited by package
2. Pulse width limited by the maximum junction temperature
3.  $V_{DD} = 50V, I_{AS} = 0.5A, L = 10mH, R_G = 25\Omega$ , Starting  $T_J = 25^\circ\text{C}$
4.  $I_{SD} \leq 0.5A, di/dt \leq 200A/\mu S, V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$
5. Pulse test:  $PW \leq 300\mu s$ , duty cycle  $\leq 2\%$
6. For DESIGN AID ONLY, not subject to production testing.
7. Essentially Independent of Operating Temperature.

**ORDERING INFORMATION**

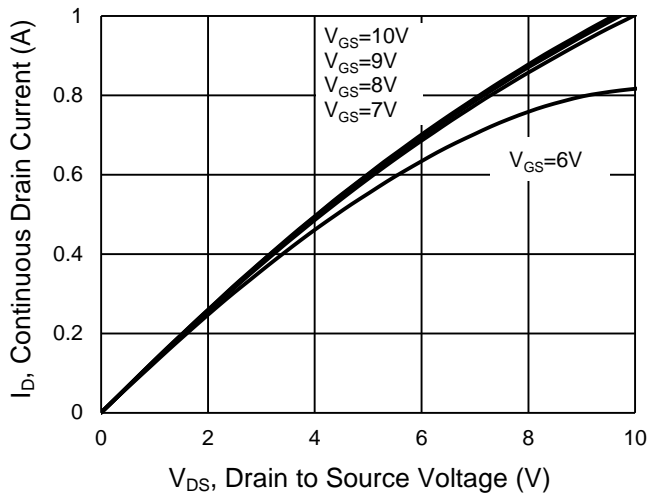
<b>PART NO.</b>	<b>PACKAGE</b>	<b>PACKING</b>
TSM1NB60SCT B0	TO-92	1,000pcs / Bulk
TSM1NB60SCT A3	TO-92	2,000pcs / Ammo
TSM1NB60SCT B0G	TO-92	1,000pcs / Bulk
TSM1NB60SCT A3G	TO-92	2,000pcs / Ammo

*Not Recommended*

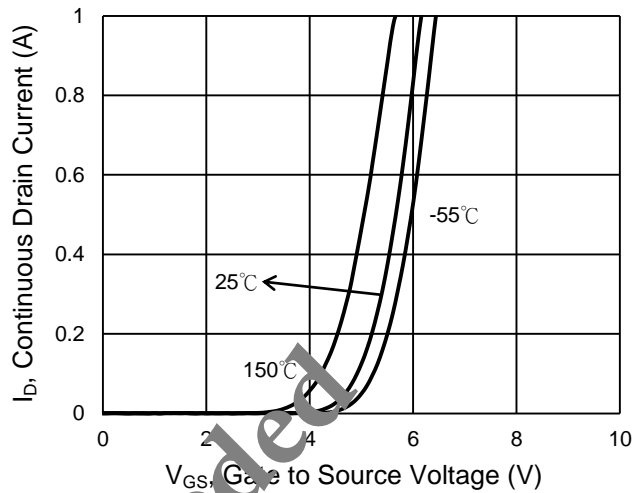
**CHARACTERISTICS CURVES**

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

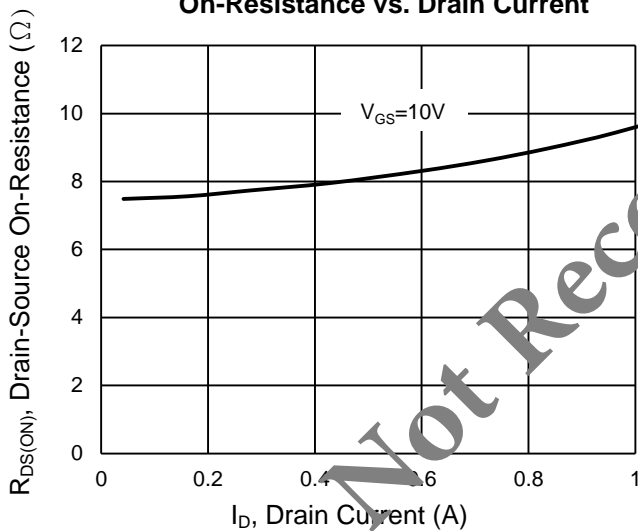
**Output Characteristics**



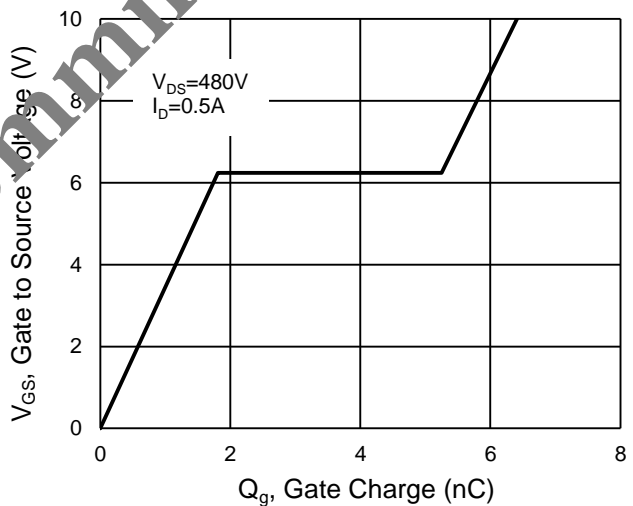
**Transfer Characteristics**



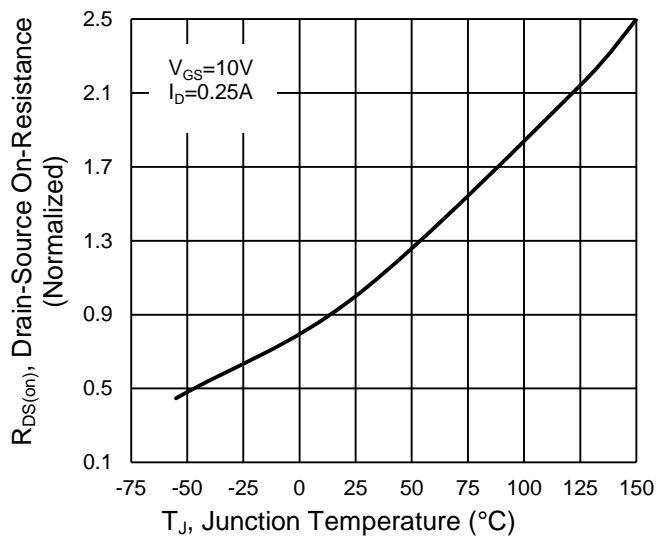
**On-Resistance vs. Drain Current**



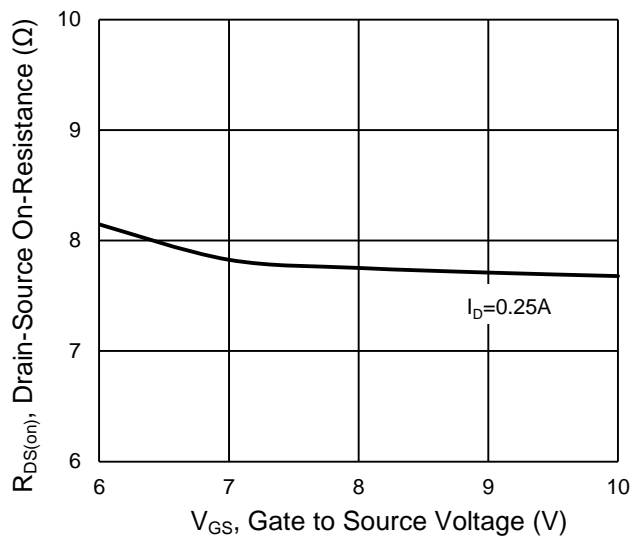
**Gate Source Voltage vs. Gate Charge**



**On-Resistance vs. Junction Temperature**



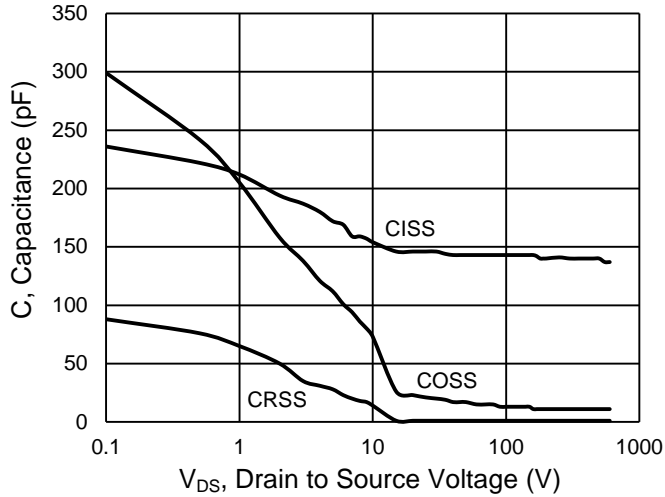
**On-Resistance vs. Gate-Source Voltage**



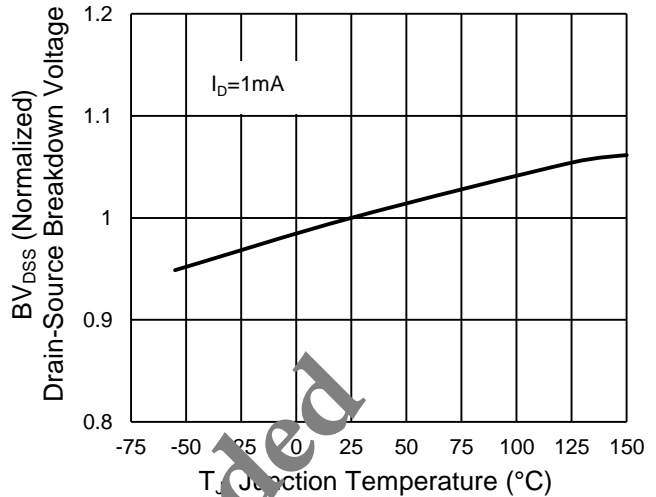
**CHARACTERISTICS CURVES**

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

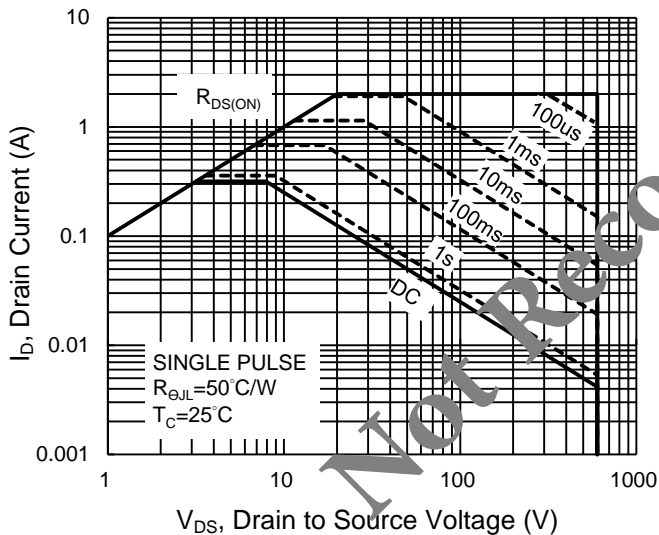
**Capacitance vs. Drain-Source Voltage**



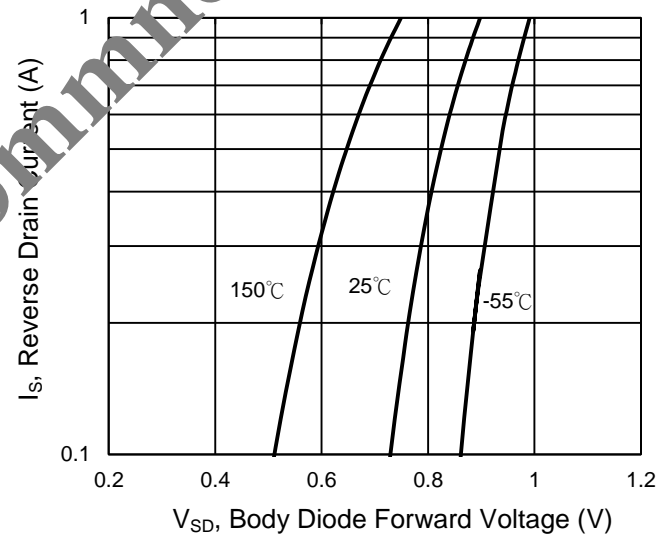
**BV<sub>DSS</sub> vs. Junction Temperature**



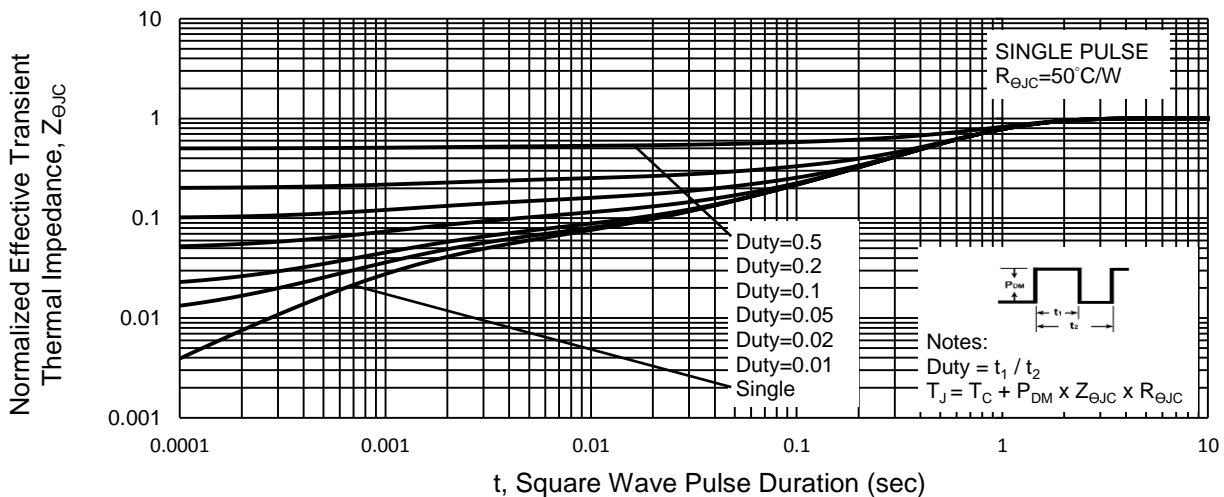
**Maximum Safe Operating Area, Junction-to-Case**



**Source-Drain Diode Forward Current vs. Voltage**

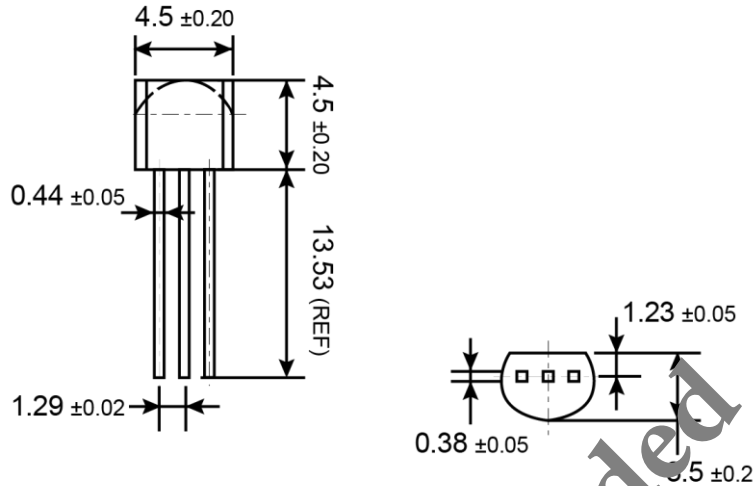


**Normalized Thermal Transient Impedance, Junction-to-Case**



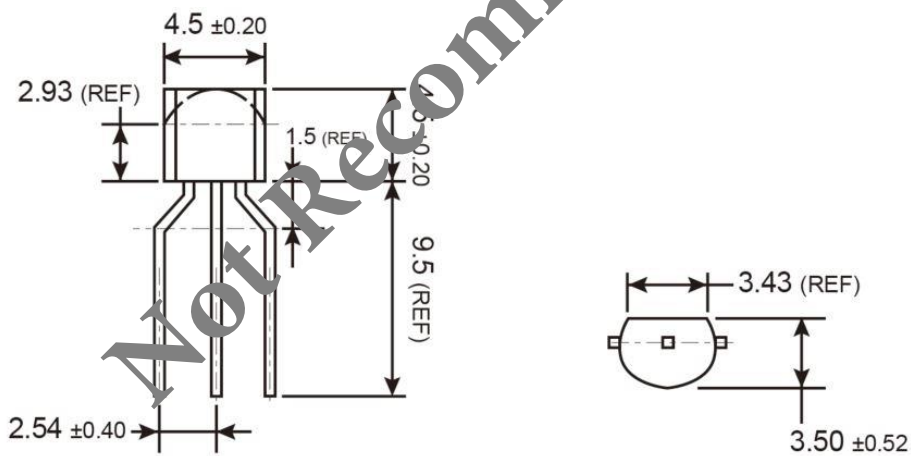
**PACKAGE OUTLINE DIMENSIONS** (Unit: Millimeters)

**TO-92**

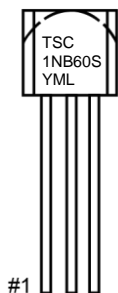


**PACKAGE OUTLINE DIMENSIONS** (Unit: Millimeters)

**TO-92 AMMO PACK**



**MARKING DIAGRAM**



- Y** = Year Code
- M** = Month Code
  - (**A**=Jan, **B**=Feb, **C**=Mar, **D**=Apr, **E**=May, **F**=Jun, **G**=Jul, **H**=Aug, **I**=Sep, **J**=Oct, **K**=Nov, **L**=Dec)
  - = Month Code for Halogen Free Product
  - (**O**=Jan, **P**=Feb, **Q**=Mar, **R**=Apr, **S**=May, **T**=Jun, **U**=Jul, **V**=Aug, **W**=Sep, **X**=Oct, **Y**=Nov, **Z**=Dec)
- L** = Lot Code

**Not Recommended**

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